EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L15	5654	Sumitomo.as. and (suscept$4 holder chuck$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 12:34
L16	99	15 and ((ceramic "Al.sub.2O. sub.3" ("Al.sub.2" adj "O. sub.3")) same metal$4 same (composit$3 compound mix$4 combinat$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 12:35
L17	160	(suscept$4 holder chuck$3). clm. and ((ceramic "Al.sub.2O. sub.3" ("Al.sub.2" adj "O. sub.3")) same metal$4 same (composit$3 compound mix$4 combinat$3)).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 12:36
L18	81	16 and (substrate wafer carrier) and heat$3	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 12:37
L19	41	17 and ((substrate wafer carrier) and heat$3).clm.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 12:37
L20	50	18 and (@ad<"20030605" @rlad<"20030605")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 12:38
L21	50	(US-20050089436-$ or US-20050025654-$ or US-20030221854-$ or US-20030123213-$ or US-20030089687-$ or US-20030085206-$ or US-20030071260-$ or US-20030066608-$ or US-20030066587-$ or US-20030029569-$ or US-20020185488-$ or US-20020051353-$ or US-20020034651-$ or US-20010001622-$).did. or (US-6768079-$ or US-6693789-$ or US-7211153-$ or US-7090423-$ or US-6950297-$ or US-6881048-$ or US-6872908-$ or	US-PGPUB; USPAT	OR	OFF	2008/03/28 12:52

		US-6814917-$ or US-6800360-$ or US-6770379-$ or US-6737168-$ or US-6724018-$ or US-6689984-$ or US-6664515-$ or US-6544654-$ or US-6534190-$ or US-6444957-$ or US-6423400-$ or US-6388273-$ or US-6383446-$ or US-6345917-$ or US-6220765-$ or US-6183874-$ or US-6183846-$ or US-6074893-$ or US-5871850-$).did. or (US-5800152-$ or US-5766751-$ or US-5712030-$ or US-5616423-$ or US-5252543-$ or US-5084265-$ or US-5028583-$ or US-4937226-$ or US-4383957-$ or US-4303442-$).did.				
L22	50	21 and ((ceramic "Al.sub.2O.sub.3" ("Al.sub.2" adj "O.sub.3")) same metal$4 same (composit$3 compound mix$4 combinat$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 12:52
S1	1	"20040244695"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/09/14 20:20
S2	13	(("20020049389") or ("20010042512") or ("6558736") or ("6015465") or ("5609721") or ("5580822") or ("5420043") or ("5650361") or ("6376340") or ("4402994") or ("6107197") or ("6218301")).PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2005/08/18 16:54
S3	3	S2 and holder and (metal$3 and ceramic$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 16:57
S4	3	S2 and (suscept$3 or holder) and (metal$3 and ceramic$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 19:07
S5	516	substrate and chamber and ((hold$3 or suscept$3) with (ceramic and metal$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 21:06
S6	27	S5 and (modulus and (heat or thermal) and coefficien$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 19:10

S7	6	S6 and ((hold$3 or suscept$3 or electrode or cathod or anode) with (composit$3 or composit$3 or combinat$3) with (metal$3 and ceramic$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 19:12
S8	30	("4645218" | "5155652" | "5191506" | "5280156" | "5376213" | "5460684" | "5478429" | "5527584" | "5529657" | "5581874" | "5600530" | "5606484" | "5625526" | "5665260" | "5671116" | "5737178" | "5745331" | "5818693" | "5827585" | "5858100" | "5886863" | "5886864" | "5949650" | "5958813" | "5968273" | "5978202" | "5986747" | "6048434" | "6072685" | "6094334").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/18 20:18
S9	21	S6 not S7	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/18 20:18
S10	9	S9 and (young$3)	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/18 20:24
S11	12	S9 not S10	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 20:25
S12	66	hashikura-manabu.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 21:05
S13	132	nakata-hirohiko.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 21:05
S14	59	kuibira-akira.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 21:06
S15	210	natsuhara-masuhiro.in.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 21:06
S16	277	S12 S13 S14 S15	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 21:06
S17	32	S16 and chamber and ((chuck $3 or hold$3 or suscept$3) with (cerami$3 and metal$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 21:08

S18	1	S17 and young$3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 21:08
S19	14	S17 and ((chuck$3 or hold$3 or suscept$3) with (cerami$3 and metal$3)).clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/08/18 21:08
S23	353	((substrate or wafer) near3 (suscept$3 or holder or receiver or keep$4) with (form $3 or creat$3 or manufactur $4)) and (ceramic or "SiC" or "Al.sub.2O.sub.3" or "AlN" or "WC" or "BN") with (metal$3 or "Al" or "Si" or "Cu") with (composit$4 or compound or mix$3 or mixtur$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/09 18:41
S24	42	S23 and modulus	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/09 18:42
S25	39	S24 and (@ad<"20030605" or @rlad<"20030605")	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/09 19:35
S26	26	S25 and sint$4	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/09 18:43
S27	23	S26 and (stand$3 or support $3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/09 19:32
S28	16	S25 not S27	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/09 19:32
S29	268	(S23 not S25) and (@ad<"20030605" or @rlad<"20030605")	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/09/16 19:23
S30	180	S29 and (chamber or vessel)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/09 19:36
S31	8	S30 and sint$3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/09 19:37

S32	3	"6508884"	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/10 15:33
S33	3	S32 and electrode	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/02/10 15:33
S36	108	(susceptor same (cermet (metal$4 near2 matrix near2 composit$3) (hybrid adj composit$3) (composit$4 with ceramic with metal$4)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 17:37
S40	112	(susceptor same (cermet (metal$4 near2 matrix near2 composit$3) (hybrid adj composit$3) ((composit$4 mixture) with ceramic with metal$4)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 18:45
S41	49	S40 and (semiconduct$3 (liquid adj crystal$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 18:46
S42	45	S41 and (@ad<"20030605" @rlad<"20030605")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 17:39
S43	11	S42 and ((composit$3 mixture) with uniform$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 17:43
S44	34	S42 not S43	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 17:44
S45	12	(US-20030085206-$ or US-20030064225-$ or US-20020084036-$ or US-20020036201-$ or US-20020006678-$).did. or (US-6891138-$ or US-6768079-$ or US-6693789-$ or US-6554907-$ or US-6486542-$ or US-6160244-$).did. or (US-20040042152-$).did.	US-PGPUB; USPAT; DERWENT	OR	ON	2006/09/15 18:05

S46	12	S45 and (susceptor and (cermet (metal$4 near2 matrix near2 composit$3) (hybrid adj composit$3) ((composit$4 mixture) with ceramic with metal$4)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 18:45
S47	12	S46 and (semiconduct$3 (liquid adj crystal$4))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 18:47
S48	9	S47 and (sinter$3 powder$3 infiltrat$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 18:48
S49	0	S48 and (sinter$3 and infiltrat $3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 18:48
S50	9	S48 and (heat$4 resist$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 19:37
S51	7	S50 and uniform	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/15 19:37
S52	20	(US-20020075624-$ or US-20040244695-$ or US-20040217105-$ or US-20030079684-$ or US-20030064225-$).did. or (US-5886863-$ or US-5580822-$ or US-5420043-$ or US-6693789-$ or US-6490146-$ or US-6094334-$ or US-5625526-$ or US-6486542-$ or US-6475606-$ or US-6693790-$ or US-6508884-$ or US-6891138-$ or US-6768079-$ or US-6160244-$).did. or (US-20040042152-$).did.	US-PGPUB; USPAT; DERWENT	OR	ON	2006/09/16 19:02

S53	0	S52 and (infultrat$3 same (porous or pore or hole or void))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/16 19:23
S54	0	S52 and (infultrat$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/16 19:03
S55	3	S52 and (infiltrat$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/16 19:20
S56	77	((susceptor chuck) and (infiltrat $3 with (composit$4 cermet) with (ceramic insulat$3 dielectric)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/16 19:22
S57	67	S56 and (infiltrat$3 same (porous or pore or hole or void))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/09/16 19:23
S58	55	S57 and (@ad<"20030605" or @rlad<"20030605")	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/09/16 19:24
S59	46	S58 and uniform$3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/09/16 19:24
S60	27	S59 and (ceramic with metal$4 with composit$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2006/09/16 19:25
S61	1	("6490146").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/09/15 20:11
S62	1	S61 and (dielectric "115")	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 20:12

S63	33	("4645218" | "5155652" | "5191506" | "5280156" | "5376213" | "5460684" | "5478429" | "5527584" | "5529657" | "5581874" | "5600530" | "5606484" | "5625526" | "5665260" | "5671116" | "5737178" | "5745331" | "5818693" | "5827585" | "5858100" | "5886863" | "5886864" | "5949650" | "5958813" | "5968273" | "5978202" | "5986747" | "6048434" | "6072685" | "6094334").PN. OR ("6490146").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2007/09/15 20:42
S64	1	("20030064225").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	OFF	2007/09/15 20:55
S65	1	S64 and (heat$4)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 21:02
S66	1	S64 and (heat$3 with electric $3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 21:04
S67	1	S64 and (heat$3 with (resist$3 electric$3))	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 21:05
S68	2	10/709889	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 23:01
S69	0	S68 and ((thermal$3 heat$3) near4 isolat$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 23:03
S70	0	S68 and ((thermal$3 heat$3) with isolat$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 23:03
S71	2	S68 and ((thermal$3 heat$3) same isolat$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2007/09/15 23:03
S72	843	361/234.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:14

S73	135	H02N13/00.ipc.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:14
S74	810	257/703.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:17
S75	131	257/648.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:19
S76	1029	H01L21/683.ipc.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:21
S77	2932	118/725.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:31
S78	4239	257/703,705,746,648,e29.075, e21.035,e21.203,e21.204, e39.009,e23.009,e23.112.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:34
S79	8998	S72 S73 S74 S75 S76 S77 S78	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:35
S80	3179	S79 and chamber	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:35
S81	2930	S79 and (suscept$4 holder chuck$3)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:36
S82	1892	S80 and S81	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:36

S83	1809	S79 and (ceramic same metal $4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:36
S84	785	S79 and (ceramic same metal $4 same (composit$3 compound mix$4 combinat$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:37
S85	148	S82 and S84	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:38
S86	129	S85 and (@ad<"20040603" @rlad<"20040603")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:38
S87	120	S85 and (@ad<"20030605" @rlad<"20030605")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; IBM_TDB	OR	OFF	2008/03/28 01:38

3/28/2008 1:41:45 PM
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